

# 2SC1573, 2SC1573A, 2SC1573B

## Silicon NPN triple diffusion planar type

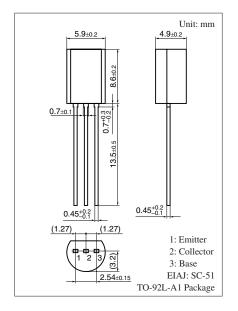
For high breakdown voltage general amplification For small TV video output Complementary to 2SC1573 and 2SA0879

#### ■ Features

- High collector-emitter voltage (Base open) V<sub>CEO</sub>
- High transition frequency f<sub>T</sub>

#### ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Collector-base voltage	2SC1573	V <sub>CBO</sub>	250	V
(Emitter open)	2SC1573A		300	
	2SC1573B		400	
Collector-emitter voltage	2SC1573	V <sub>CEO</sub>	200	V
(Base open)	2SC1573A		300	
	2SC1573B		400	
Emitter-base voltage	2SC1573	$V_{EBO}$	5	V
(Collector open)	2SC1573A		7	
	2SC1573B			
Collector current	$I_C$	70	mA	
Peak collector current	$I_{CP}$	100	mA	
Collector power dissipation	$P_{C}$	1	W	
Junction temperature	$T_j$	150	°C	
Storage temperature	T <sub>stg</sub>	-55 to +150	°C	



### **Panasonic**

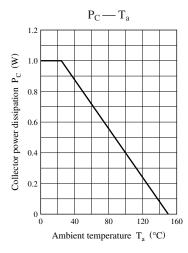
### ■ Electrical Characteristics $T_a = 25$ °C $\pm 3$ °C

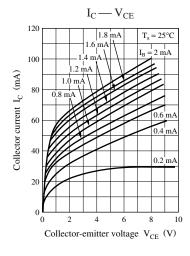
Parameter		Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter voltage	2SC1573	V <sub>CEO</sub>	$I_C = 100 \ \mu A, I_B = 0$	200			V
(Base open)	2SC1573A			300			
	2SC1573B			400			
Emitter-base voltage	2SC1573	$V_{EBO}$	$I_E = 1 \mu A, I_C = 0$	5			V
(Collector open)	2SC1573A			7			
	2SC1573B			7			
Collector-base cut-off current	2SC1573	$I_{CBO}$	$V_{CB} = 12 \text{ V}, I_E = 0$			2	μΑ
(Emitter open)	2SC1573A						
	2SC1573B		$V_{CB} = 200 \text{ V}, I_{E} = 0$			10	
Forward current transfer ratio	2SC1573	h <sub>FE</sub> *	$V_{CE} = 10 \text{ V}, I_{C} = 5 \text{ mA}$	60		220	_
	2SC1573A			30		220	
	2SC1573B						
Collector-emitter saturation	voltage	V <sub>CE(sat)</sub>	$I_{\rm C} = 50 \text{ mA}, I_{\rm B} = 5 \text{ mA}$			1.2	V
Transition frequency		$f_T$	$V_{CB} = 10 \text{ V}, I_E = -10 \text{ mA}, f = 200 \text{ MHz}$	50	80		MHz
Collector output capacitance	2SC1573	C <sub>ob</sub>	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		5	10	pF
(Common base, input	2SC1573A				4	8	
open circuited)	2SC1573B				4	8	

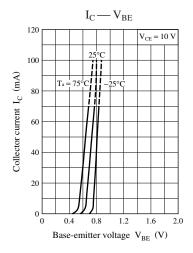
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

#### 2. \*: Rank classification (2SC1573 for ranks Q and R only)

Rank	Р	Q	R	
$h_{FE}$	30 to 100	60 to 150	100 to 220	

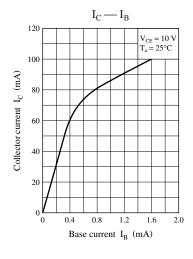


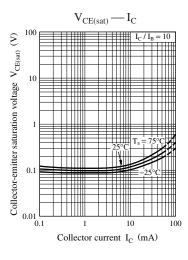


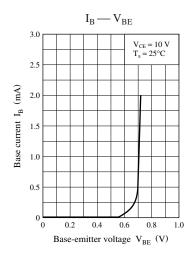


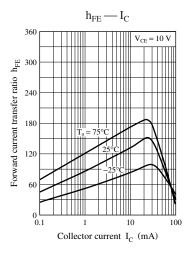
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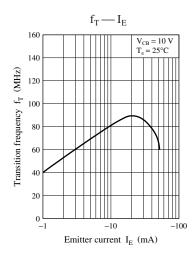
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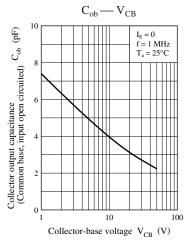


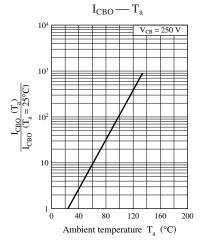


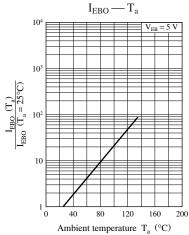


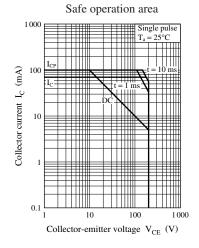












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